# LNJ876YK6AA

### Round Type

φ3.2 mm

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	125	mW	
Forward current	$I_{\mathrm{F}}$	50	mA	
Pulse forward current *	$I_{FP}$	150	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

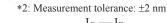
#### ■ Lighting Color

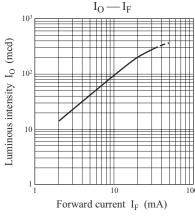
• Soft Orange

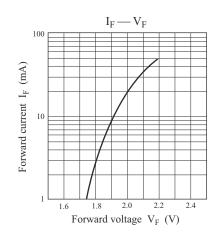
#### ■ Electro-Optical Characteristics $T_a = 25$ °C

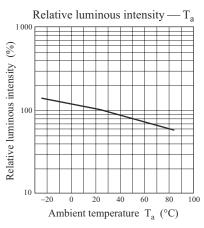
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I <sub>O</sub>	$I_F = 20 \text{ mA}$	40	200		mcd
Reverse current	$I_R$	$V_R = 4 V$			100	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 20 \text{ mA}$		2.0	2.5	V
Dominant emission wavelength *2	$\lambda_{\mathrm{d}}$	$I_F = 20 \text{ mA}$		605		nm
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 20 \text{ mA}$		610		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$		17		nm

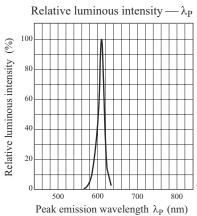
Note) \*1: Measurement tolerance: ±20%

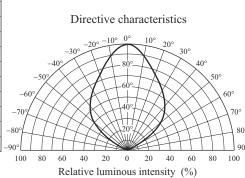


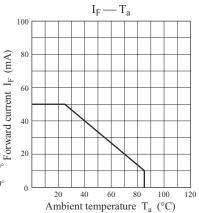




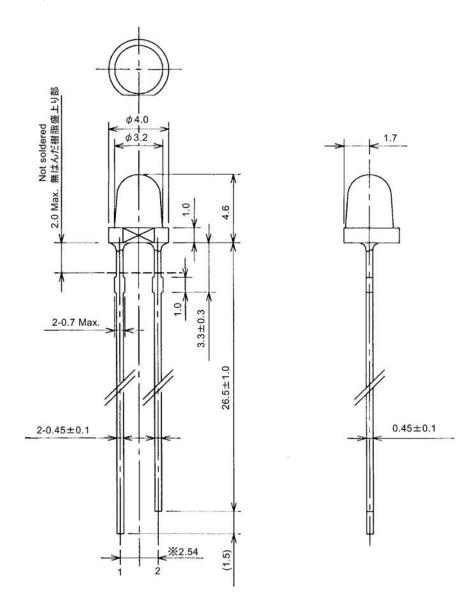








### ■ Package (Unit: mm)



- Pin name
  - 1: Anode
  - 2: Cathode

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